



Progress in Nondestructive Testing and Evaluation

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Message from the Guest Editors

The purpose of this Special Issue is to shed light on new frontiers in NDT&E, including novel approaches and devices for NDT&E, inverse problem evaluation, and pioneering interdisciplinary research on NDT&E and deep learning. Owing to technical breakthroughs in the field of NDT&E, numerous endeavors are being undertaken in, but not limited to, the following areas:

- Innovation applications and methodologies in the field of NDT&E;
- Inversion methods in NDT&E;
- Interdisciplinary of NDT&E and machine learning;
- Simulation methods in in NDT&E;
- Automation of NDT&E;
- Information fusion in multi-NDTs.





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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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